

FEATURES

Pb-free, 16-lead, wide body SOIC package Low power operation 5 V operation 1.0 mA per channel max @ 0 Mbps to 2 Mbps 3.5 mA per channel max @ 10 Mbps 3 V operation 0.7 mA per channel max @ 0 Mbps to 2 Mbps 2.1 mA per channel max @ 10 Mbps 3 V/5 V level translation High temperature operation: 105°C Up to 10 Mbps data rate (NRZ) Programmable default output state Safety and regulatory approvals UL recognition: 2500 V rms for 1 minute per UL 1577 CSA component acceptance notice #5A VDE certificate of conformity DIN EN 60747-5-2 (VDE 0884 Part 2): 2003-01 DIN EN 60950 (VDE 0805): 2001-12; EN 60950: 2000 VIORM = 560 V peak

APPLICATIONS

General-purpose unidirectional multichannel isolation

Triple- and Quad-Channel Unidirectional Digital Isolators ADuM1310/ADuM1410

GENERAL DESCRIPTION

The ADuM1310 and ADuM1410 are unidirectional tripleand quad-channel isolators based on Analog Devices' *i*Coupler® technology. Combining high speed CMOS and monolithic coreless transformer technology, these isolation components provide outstanding performance characteristics superior to alternatives such as optocoupler devices.

By avoiding the use of LEDs and photodiodes, *i*Coupler devices remove the design difficulties commonly associated with optocouplers. The typical optocoupler concerns regarding uncertain current transfer ratios, nonlinear transfer functions, and temperature and lifetime effects are eliminated with the simple *i*Coupler digital interfaces and stable performance characteristics. The need for external drivers and other discretes is eliminated with these *i*Coupler products. Furthermore, *i*Coupler devices run at one-tenth to one-sixth the power consumption of optocouplers at comparable signal data rates.

The ADuM1310 and ADuM1410 isolators provide three or four independent isolation channels at data rates up to 10 Mbps. Both models operate with the supply voltage of either side ranging from 2.7 V to 5.5 V, providing compatibility with lower voltage systems as well as enabling a voltage translation functionality across the isolation barrier. Each product also has a default output control pin with which the user can define the logic state the outputs are to take on in the absence of the input V_{DD1} power. Unlike other optocoupler alternatives, the ADuM1310 and ADuM1410 have a patented refresh feature that ensures dc correctness in the absence of input logic transitions and during power-up/power-down conditions.

04904-0-001

FUNCTIONAL BLOCK DIAGRAMS

One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A. Tel: 781.329.4700 www.analog.com Fax: 781.461.3113 © 2005 Analog Devices, Inc. All rights reserved.

Rev. C

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

TABLE OF CONTENTS

REVISION HISTORY

11/05—Rev. SpB to Rev. C

6/04—Revision Sp0: Initial Version

SPECIFICATIONS

ELECTRICAL CHARACTERISTICS—5 V OPERATION1

 4.5 V \le V_{DD1} \le 5.5 V, 4.5 V \le V_{DD2} \le 5.5 V; all min/max specifications apply over the entire recommended operation range, unless otherwise noted; all typical specifications are at $T_A = 25^{\circ}C$, $V_{DD1} = V_{DD2} = 5 V$.

¹ All voltages are relative to their respective ground.

- 2 Supply current values are for all four channels combined running at identical data rates. Output supply current values are specified with no output load present. The supply current associated with an individual channel operating at a given data rate can be calculated as described in the Power Consumption section. See Figure 6 through Figure 8 for information on the per-channel supply current as a function of the data rate for unloaded and loaded conditions. See Figure 9 through Figure 12 for total I_{DD1} and I_{DD2} supply currents as a function of the data rate for the ADuM1310/ADuM1410 channel configurations.
- ³ The minimum pulse width is the shortest pulse width at which the specified pulse width distortion is guaranteed.
- 4 The maximum data rate is the fastest data rate at which the specified pulse width distortion is guaranteed.
- 5 t $_{\rm{PHL}}$ propagation delay is measured from the 50% level of the falling edge of the V $_{\rm{k}}$ signal to the 50% level of the falling edge of the V $_{\rm{ox}}$ signal. t $_{\rm{P-L}}$ propagation delay is measured from the 50% level of the rising edge of the V_{Ix} signal to the 50% level of the rising edge of the V_{Ox} signal.
- 6 t_{PSK} is the magnitude of the worst-case difference in t_{PHL} and/or t_{PLH} that is measured between units at the same operating temperature, supply voltages, and output load within the recommended operating conditions.
- ⁷ Channel-to-channel matching is the absolute value of the difference in propagation delays between any two channels within the same component.
⁸ CM,, is the maximum common-mode voltage slew rate that can be sustained
- ⁸ CM_H is the maximum common-mode voltage slew rate that can be sustained while maintaining V₀ > 0.8 V_{DD2}. CM_L is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_0 < 0.8$ V. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges. The transient magnitude is the range over which the common mode is slewed.
- 9 Input enable time is the duration from when V $_{\sf{DISABLE}}$ is set low until the output states are guaranteed to match the input states in the absence of any input data logic transitions. If an input data logic transition within a given channel does occur within this time interval, the output of that channel reaches the correct state within the much shorter duration as determined by the propagation delay specifications within this data sheet. Input disable time is the duration from when V_{DISABLE} is set high until the output states are guaranteed to reach their programmed output levels, as determined by the CTRL logic state (see Table 10).
¹⁰ Dynamic supply current is the incremental amount of supply current required for a 1
- information on the per-channel supply current for unloaded and loaded conditions. See the Power Consumption section for guidance on calculating the per-channel supply current for a given data rate.

ELECTRICAL CHARACTERISTICS—3 V OPERATION1

 $2.7 V \le V_{\text{DD1}} \le 3.6 V$, $2.7 V \le V_{\text{DD2}} \le 3.6 V$; all min/max specifications apply over the entire recommended operation range, unless otherwise noted; all typical specifications are at $T_A = 25^{\circ}C$, $V_{DD1} = V_{DD2} = 3.0$ V.

¹ All voltages are relative to their respective ground.

- 2 Supply current values are for all four channels combined running at identical data rates. Output supply current values are specified with no output load present. The supply current associated with an individual channel operating at a given data rate can be calculated as described in the Power Consumption section. See Figure 6 through Figure 8 for information on the per-channel supply current as a function of the data rate for unloaded and loaded conditions. See Figure 9 through Figure 12 for total I_{DD1} and I_{DD2} supply currents as a function of the data rate for the ADuM1310/ADuM1410 channel configurations.
- ³ The minimum pulse width is the shortest pulse width at which the specified pulse width distortion is guaranteed.
- 4 The maximum data rate is the fastest data rate at which the specified pulse width distortion is guaranteed.
- 5 t $_{\rm{PHL}}$ propagation delay is measured from the 50% level of the falling edge of the V $_{\rm{k}}$ signal to the 50% level of the falling edge of the V $_{\rm{ox}}$ signal. t $_{\rm{P-L}}$ propagation delay is measured from the 50% level of the rising edge of the V_{Ix} signal to the 50% level of the rising edge of the V_{Ox} signal.
- 6 t_{PSK} is the magnitude of the worst-case difference in t_{PHL} and/or t_{PLH} that is measured between units at the same operating temperature, supply voltages, and output load within the recommended operating conditions.
- ⁷ Channel-to-channel matching is the absolute value of the difference in propagation delays between any two channels within the same component.
⁸ CM,, is the maximum common-mode voltage slew rate that can be sustained
- ⁸ CM_H is the maximum common-mode voltage slew rate that can be sustained while maintaining V₀ > 0.8 V_{DD2}. CM_L is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_0 < 0.8$ V. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges. The transient magnitude is the range over which the common mode is slewed.
- 9 Input enable time is the duration from when V $_{\sf{DISABLE}}$ is set low until the output states are guaranteed to match the input states in the absence of any input data logic transitions. If an input data logic transition within a given channel does occur within this time interval, the output of that channel reaches the correct state within the much shorter duration as determined by the propagation delay specifications within this data sheet. Input disable time is the duration from when V_{DISABLE} is set high
- until the output states are guaranteed to reach their programmed output levels, as determined by the CTRL logic state (see Table 10).
¹⁰ Dynamic supply current is the incremental amount of supply current required for a 1 on the per-channel supply current for unloaded and loaded conditions. See the Power Consumption section for guidance on calculating the per-channel supply current for a given data rate.

ELECTRICAL CHARACTERISTICS—MIXED 5 V/3 V OR 3 V/5 V OPERATION1

5 V/3 V operation: 4.5 V \le V_{DD1} \le 5.5 V, 2.7 V \le V_{DD2} \le 3.6 V; 3 V/5 V operation: 2.7 V \le V_{DD1} \le 3.6 V, 4.5 V \le V_{DD2} \le 5.5 V; all min/max specifications apply over the entire recommended operation range, unless otherwise noted; all typical specifications are at T_A = 25°C; V_{DD1} = 3.0 V, V_{DD2} = 5 V; or V_{DD1} = 5 V, V_{DD2} = 3.0 V.

¹ All voltages are relative to their respective ground.

² Supply current values are for all channels combined running at identical data rates. Output supply current values are specified with no output load present. The supply current associated with an individual channel operating at a given data rate can be calculated as described in the Power Consumption section. See Figure 6 through Figure 8 for information on the per-channel supply current as a function of the data rate for unloaded and loaded conditions. See Figure 9 through Figure 12 for total I_{DD1} and I_{DD2} supply currents as a function of the data rate for the ADuM1310/ADuM1410.

³ The minimum pulse width is the shortest pulse width at which the specified pulse width distortion is guaranteed.

4 The maximum data rate is the fastest data rate at which the specified pulse width distortion is guaranteed.

 5 t $_{\rm{PHL}}$ propagation delay is measured from the 50% level of the falling edge of the V $_{\rm{k}}$ signal to the 50% level of the falling edge of the V $_{\rm{ox}}$ signal. t $_{\rm{PL}}$ propagation delay is measured from the 50% level of the rising edge of the V_{Ix} signal to the 50% level of the rising edge of the V_{Ox} signal.

 6 t_{PSK} is the magnitude of the worst-case difference in t_{PHL} and/or t_{PLH} that is measured between units at the same operating temperature, supply voltages, and output load within the recommended operating conditions.

⁷ Channel-to-channel matching is the absolute value of the difference in propagation delays between any two channels within the same component.
⁸ CM is the maximum common-mode voltage slew rate that can be sustained wh

 8 CM_H is the maximum common-mode voltage slew rate that can be sustained while maintaining V₀ > 0.8 V_{DD2}. CM_L is the maximum common-mode voltage slew rate that can be sustained while maintaining $V_0 < 0.8$ V. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges. The transient magnitude is the range over which the common mode is slewed.

 9 Input enable time is the duration from when V $_{\text{DISABLE}}$ is set low until the output states are guaranteed to match the input states in the absence of any input data logic transitions. If an input data logic transition within a given channel does occur within this time interval, the output of that channel reaches the correct state within the much shorter duration as determined by the propagation delay specifications within this data sheet. Input disable time is the duration from when V_{DISABLE} is set high until the output states are quaranteed to reach their

¹⁰ Dynamic supply current is the incremental amount of supply current required for a 1 Mbps increase in signal data rate. See Figure 6 through Figure 8 for information on the per-channel supply current for unloaded and loaded conditions. See the Power Consumption section for guidance on calculating the per-channel supply current for a given data rate.

PACKAGE CHARACTERISTICS

Table 4.

¹ Device considered a 2-terminal device. Pin 1, Pin 2, Pin 3, Pin 4, Pin 5, Pin 6, Pin 7, and Pin 8 shorted together and Pin 9, Pin 10, Pin 10, Pin 11, Pin 12, Pin 13, Pin 14, Pin 15, and Pin 16 shorted together.

2 Input capacitance is from any input data pin to ground.

REGULATORY INFORMATION

The ADuM1x10 is approved by the following organizations.

Table 5.

1 In accordance with UL1577, each ADuM1310 and ADuM1410 is proof tested by applying an insulation test voltage ≥3000 V rms for 1 second (current leakage detection limit = 5μ A).

2 In accordance with DIN EN 60747-5-2, each ADuM1310 and ADuM1410 is proof tested by applying an insulation test voltage ≥1050 V peak for 1 second (partial discharge detection limit $= 5$ pC).

INSULATION AND SAFETY-RELATED SPECIFICATIONS

Table 6.

DIN EN 60747-5-2 (VDE 0884 PART 2) INSULATION CHARACTERISTICS

Table 7.

This isolator is suitable for basic electrical isolation only within the safety limit data. Maintenance of the safety data shall be ensured by means of protective circuits. The * marking on packages denotes DIN EN 60747-5-2 approval for 560 V peak working voltage.

RECOMMENDED OPERATING CONDITIONS

¹ All voltages are relative to their respective ground. See the DC Correctness and Magnetic Field Immunity section for information on immunity to external magnetic fields.

ABSOLUTE MAXIMUM RATINGS

Ambient temperature = 25°C, unless otherwise noted.

Table 9.

¹ All voltages are relative to their respective ground.

² V_{DDI} and V_{DDO} refer to the supply voltages on the input and output sides of a given channel, respectively.
³ See Figure 3 for maximum rated current values for various temperatures.

³ See Figure 3 for maximum rated current values for various temperatures.

4 Refers to common-mode transients across the insulation barrier. Common-mode transients exceeding the Absolute Maximum Ratings can cause latch-up or permanent damage.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

Table 10. Truth Table (Positive Logic)

¹ V_{IX} and V_{OX} refer to the input and output signals of a given channel (A, B, C, or D).

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

Figure 5. ADuM1410 Pin Configuration

*Pin 2 and Pin 8 are internally connected. Connecting both to GND₁ is recommended. Pin 9 and Pin 15 are internally connected. Connecting both to GND₂ is **recommended.**

Table 11. ADuM1310 Pin Function Descriptions

TYPICAL PERFORMANCE CHARACTERISTICS

Figure 6. Typical Input Supply Current per Channel vs. Data Rate for 5 V and 3 V Operation

Figure 7. Typical Output Supply Current per Channel vs. Data Rate for 5 V and 3 V Operation (No Output Load)

Figure 8. Typical Output Supply Current per Channel vs. Data Rate for 5 V and 3 V Operation (15 pF Output Load)

Figure 9. Typical ADuM1310 V_{DD1} Supply Current vs. Data Rate for 5 V and 3 V Operation

Figure 10. Typical ADuM1310 V_{DD2} Supply Current vs. Data Rate for 5 V and 3 V Operation

Figure 11. Typical ADuM1410 V_{DD1} Supply Current vs. Data Rate for 5 V and 3 V Operation

Figure 12. Typical ADuM1410 V_{DD2} Supply Current vs. Data Rate for 5 V and 3 V Operation

APPLICATION INFORMATION

PC BOARD LAYOUT

The ADuM1x10 digital isolator requires no external interface circuitry for the logic interfaces. Power supply bypassing is strongly recommended at the input and output supply pins (see Figure 13). Bypass capacitors are most conveniently connected between Pin 1 and Pin 2 for V_{DD1} and between Pin 15 and Pin 16 for V_{DD2} . The capacitor value should be between 0.01 μ F and 0.1 μF. The total lead length between both ends of the capacitor and the input power supply pin should not exceed 20 mm. Bypassing between Pin 1 and Pin 8 and between Pin 9 and Pin 16 should also be considered unless the ground pair on each package side is connected close to the package.

Figure 13. Recommended Printed Circuit Board Layout

PROPAGATION DELAY-RELATED PARAMETERS

Propagation delay is a parameter that describes the length of time it takes for a logic signal to propagate through a component. The propagation delay to a logic low output can differ from the propagation delay to a logic high output.

Pulse width distortion is the maximum difference between these two propagation delay values and is an indication of how accurately the input signal's timing is preserved.

Channel-to-channel matching refers to the maximum amount the propagation delay differs between channels within a single ADuM1x10 component.

Propagation delay skew refers to the maximum amount the propagation delay differs among multiple ADuM1x10 components operated under the same conditions.

DC CORRECTNESS AND MAGNETIC FIELD IMMUNITY

Positive and negative logic transitions at the isolator input cause narrow (-1 ns) pulses to be sent via the transformer to the decoder. The decoder is bistable, and is, therefore, either set or reset by the pulses indicating input logic transitions. In the absence of logic transitions at the input for more than 2 μs, a periodic set of refresh pulses indicative of the correct input state are sent to ensure dc correctness at the output. If the decoder receives no pulses for more than about 5 μs, the input side is assumed to be unpowered or nonfunctional, in which case the isolator output is forced to a default state (see Table 10) by the watchdog timer circuit.

The limitation on the device's magnetic field immunity is set by the condition in which induced voltage in the transformer's receiving coil is sufficiently large to either falsely set or reset the decoder. The analysis below defines such conditions. The ADuM1x10's 3 V operating condition is examined because it represents the most susceptible mode of operation.

The pulses at the transformer output have an amplitude greater than 1.0 V. The decoder has a sensing threshold of about 0.5 V, therefore establishing a 0.5 V margin in which induced voltages can be tolerated. The voltage induced across the receiving coil is given by

 $V = (-dβ/dt)ΣΠr_n²; n = 1, 2, ..., N$

where:

 $β$ is the magnetic flux density (gauss). *N* is the number of turns in the receiving coil. r_n is the radius of the n^{th} turn in the receiving coil (cm).

Given the geometry of the receiving coil in the ADuM1x10 and an imposed requirement that the induced voltage be at most 50% of the 0.5 V margin at the decoder, a maximum allowable magnetic field is calculated, as shown in Figure 15.

Figure 15. Maximum Allowable External Magnetic Flux Density

For example, at a magnetic field frequency of 1 MHz, the maximum allowable magnetic field of 0.2 kGauss induces a voltage of 0.25 V at the receiving coil. This is about 50% of the sensing threshold and does not cause a faulty output transition. Similarly, if such an event occurred during a transmitted pulse (and was of the worst-case polarity), it would reduce the received pulse from > 1.0 V to 0.75 V—still well above the 0.5 V sensing threshold of the decoder.

The preceding magnetic flux density values correspond to specific current magnitudes at given distances away from the ADuM1x10 transformers. Figure 16 expresses these allowable current magnitudes as a function of frequency for selected distances. As can be seen, the ADuM1x10 is extremely immune and can be affected only by extremely large currents operated at high frequency, very close to the component. For the 1 MHz example noted, one would have to place a 0.5 kA current 5 mm away from the ADuM1x10 to affect the component's operation.

Note that at combinations of strong magnetic field and high frequency, any loops formed by printed circuit board traces could induce sufficiently large error voltages to trigger the thresholds of succeeding circuitry. Care should be taken in the layout of such traces to avoid this possibility.

POWER CONSUMPTION

The supply current at a given channel of the ADuM1x10 isolator is a function of the supply voltage, the channel's data rate, and the channel's output load.

For each input channel, the supply current is given by

For each output channel, the supply current is given by

$$
I_{DDO} = (I_{DDO(D)} + C_L V_{DDO}) \times (2f - f_r) + I_{DDO(Q)} \qquad f > 0.5f_r
$$

where:

IDDI (D), *IDDO (D)* are the input and output dynamic supply currents per channel (mA/Mbps).

CL is the output load capacitance (pF).

V_{DDO} is the output supply voltage (V).

f is the input logic signal frequency (Hz, half of the input data rate, NRZ signaling).

f_r is the input stage refresh rate (bps).

IDDI (Q), *IDDO (Q)* are the specified input and output quiescent supply currents (mA).

To calculate the total I_{DD1} and I_{DD2} supply current, the supply currents for each input and output channel corresponding to I_{DD1} and I_{DD2} are calculated and totaled. Figure 6 and Figure 7 provide per-channel supply currents as a function of the data rate for an unloaded output condition. Figure 8 provides perchannel supply current as a function of the data rate for a 15 pF output condition. Figure 9 through Figure 12 provide total I_{DD1} and I_{DD2} supply current as a function of the data rate for ADuM1310/ADuM1410 products.

POWER-UP/POWER-DOWN CONSIDERATIONS

Given that the ADuM1310/ADuM1410 have separate supplies on either side of the isolation barrier, the power-up and powerdown characteristics relative to each supply voltage need to be considered individually.

As shown in Table 10, when V_{DD1} input power is off, the ADuM1310/ADuM1410 outputs take on a default condition as determined by the state of the CTRL pin. As the V_{DD1} supply is increased/decreased, the output of each channel transitions from/to the default condition to/from the state matching its respective signals (see Figure 17 and Figure 18).

Figure 17. V_{DD1} Power-Up/Power-Down Characteristics, Input Data = High

Figure 18. V_{DD1} Power-Up/Power-Down Characteristics, Input Data = Low

When V_{DD1} crosses the threshold for activating the refresh circuit (approximately 2 V), there can be a delay of up to 2 μs before the output is updated to the correct state depending on the timing of the next refresh pulse. When V_{DD1} is reduced from an on state below the 2 V threshold, there can be a delay of up to 5 μs before the output takes on its default state determined by the CTRL signal. This corresponds to the duration that the watchdog timer circuit at the input is designed to wait before triggering an output default state.

When the V_{DD2} output supply is below the level at which the ADuM1310/ADuM1410's output transistors are biased (about 1 V), the outputs take on a high impedance state. When V_{DD2} is above a value of about 2 V, each channel's output takes on a state matching that of its respective input. Between the values of 1 V and 2 V, the outputs are set low. This behavior is shown in Figure 19 and Figure 20.

Figure 19. V_{DD2} Power-Up/Power-Down Characteristics, Input Data = High

Figure 20. V_{DD2} Power-Up/Power-Down Characteristics, Input Data = Low

OUTLINE DIMENSIONS

Dimensions shown in millimeters and (inches)

ORDERING GUIDE

 $1 Z = Pb$ -free part.

² The addition of an -RL suffix designates a 13-inch (1,000 units) tape and reel option.

NOTES

NOTES

www.analog.com

© 2005 Analog Devices, Inc. All rights reserved. Trademarks and registered trademarks are the property of their respective owners. D04904-0-11/05(C)

Rev. C | Page 20 of 20

中发网 WWW.ZFA.CN

全球最大的PDF中文下载站

中发网

PDF 资料下载尽在中发网

版权所有 中发飞询 京ICP证041662号(³)Copyright @ 2004-2005 www.zla.cn All Rights Reserved
- 客 服 热 线 : 深圳 0755-83278916, 83278919 北京 010-62632888, 62636888